

# Ultrafast Diode 200 V, 20 A FFB20UP20S

#### **Description**

The FFB20UP20S is an ultrafast diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applications as welder application.

#### **Features**

- Ultrafast Recovery,  $t_{rr} = 45 \text{ ns}$  (@  $I_F = 20 \text{ A}$ )
- Max Forward Voltage,  $V_F = 1.15 \text{ V}$  (@  $T_C = 25^{\circ}\text{C}$ )
- Reverse Voltage, V<sub>RRM</sub> = 200 V
- Avalanche Energy Rated
- RoHS Compliant

### **Applications**

- Output Rectifiers
- SMPS, Welder, UPS
- Free-Wheeling Diode for Motor Application
- Power Switching Circuits

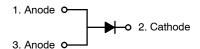
#### **ABSOLUTE MAXIMUM RATINGS**

 $T_C = 25^{\circ}C$  unless otherwise noted

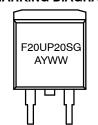
Symbol	Parameter	Rating	Unit	
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	200	V	
V <sub>RWM</sub>	Working Peak Reverse Voltage	200	V	
V <sub>R</sub>	DC Blocking Voltage	200	V	
I <sub>F(AV)</sub>	I <sub>F(AV)</sub> Average Rectified Forward Current @ T <sub>C</sub> = 115°C		Α	
I <sub>FSM</sub>	I <sub>FSM</sub> Non-repetitive Peak Surge Current 60 Hz Single Half-Sine Wave		Α	
T <sub>J</sub> , T <sub>STG</sub>	T <sub>J</sub> , T <sub>STG</sub> Operating Junction and Storage Temperature Range		°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.





#### **MARKING DIAGRAM**



F20UP20S = Specific Device Code

A = Assembly Location

Y = Year
WW = Work Week
G = Pb-Free Package

#### FFB20UP20S

THERMAL CHARACTERISTICS  $T_C = 25^{\circ}C$  unless otherwise noted

Symbol Parameter		Max	Unit	
$R_{ heta JC}$	Maximum Thermal Resistance, Junction-to-Case	2.0	°C/W	

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFB20UP20STM	F20UP20S	D <sup>2</sup> PAK	Reel	13" Dia	N/A	800

# **ELECTRICAL CHARACTERISTICS** $T_C = 25^{\circ}C$ unless otherwise noted

Parameter	ameter Conditions		Min	Тур	Max	Unit
V <sub>F</sub> (Note 1)	Forward Voltage I <sub>F</sub> = 20 A I <sub>F</sub> = 20 A	T <sub>C</sub> = 25°C T <sub>C</sub> = 100°C	_ _	- -	1.15 1.0	٧
I <sub>R</sub> (Note 1)	Reverse Current V <sub>R</sub> = 200 V V <sub>R</sub> = 200 V	T <sub>C</sub> = 25°C T <sub>C</sub> = 100°C	- -	- -	100 500	μΑ
t <sub>rr</sub>	$I_F$ = 1 A, di <sub>F</sub> /dt = 100 A/ $\mu$ s, V <sub>R</sub> = 30 V $I_F$ = 20 A, di <sub>F</sub> /dt = 200 A/ $\mu$ s, V <sub>R</sub> = 130 V	T <sub>C</sub> = 25°C	- -	- -	35 45	ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	$I_F = 20 \text{ A}, \text{ di}_F/\text{dt} = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 130 \text{ V}$	T <sub>C</sub> = 25°C	- - -	11 13 21	- - -	ns ns nC
W <sub>AVL</sub>	Avalanche Energy (L = 40 mH)			_	_	mJ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **Test Circuit and Waveforms**

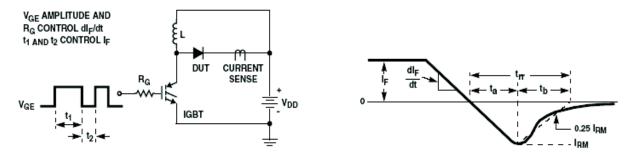


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

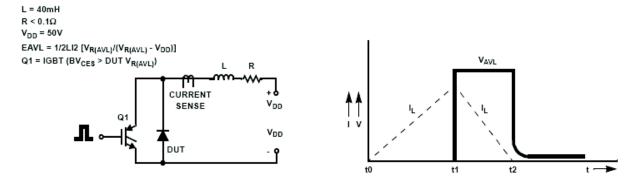


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

<sup>1.</sup> Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2%

#### FFB20UP20S

## **TYPICAL CHARACTERISTICS**

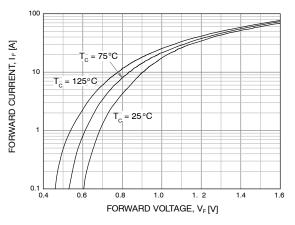
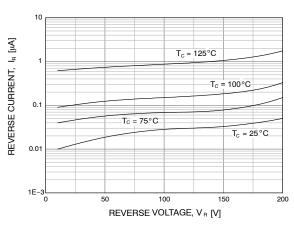
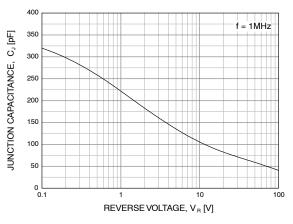


Figure 3. Typical Forward Voltage Drop



**Figure 4. Typical Reverse Current** 



**Figure 5. Typical Junction Capacitance** 

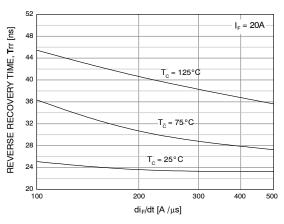


Figure 6. Typical Reverse Recovery Time

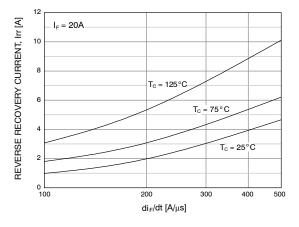


Figure 7. Typical Reverse Recovery Current

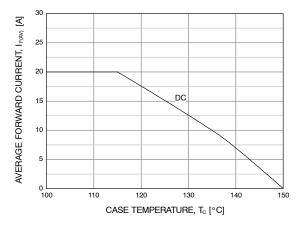
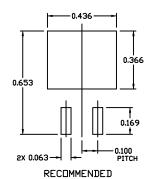


Figure 8. Forward Current Derating Curve

#### FFB20UP20S

#### PACKAGE DIMENSIONS

# D<sup>2</sup>PAK-3 (TO-263, 3-LEAD) CASE 418AJ **ISSUE F**



MOUNTING FOOTPRINT

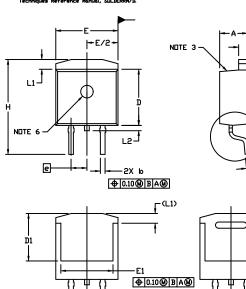
#### NOTES:

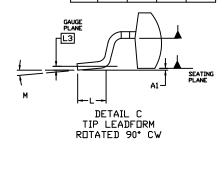
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009
- CONTROLLING DIMENSION: INCHES
- CHAMFER OPTIONAL
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.005 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE DUTERMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
- THERMAL PAD CONTOUR IS OPTIONAL WITHIN DIMENSIONS E, L1, D1, AND E1.
- OPTIONAL MOLD FEATURE.
- ... OPTIONAL CONSTRUCTION FEATURE CALL DUTS.

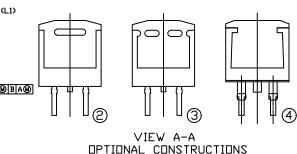
DETAIL C

Α

	INCHES		MILLIMETERS		
DIM	MIN.	MAX.	MIN.	MAX.	
Α	0.160	0.190	4.06	4.83	
A1	0.000	0.010	0.00	0.25	
b	0.020	0.039	0.51	0.99	
С	0.012	0.029	0.30	0.74	
c2	0.045	0.065	1.14	1.65	
D	0.330	0.380	8.38	9.65	
D1	0.260		6.60		
E	0.380	0.420	9.65	10.67	
E1	0.245		6.22		
e	0.100 BSC		2.54	BSC	
Н	0.575	0.625	14.60	15.88	
L	0.070	0.110	1.78	2.79	
L1		0.066		1.68	
L2		0.070		1.78	
L3	0.010 BSC		0.25	25 BSC	
М	0*	8*	0*	8.	







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